

RoHS Compliant Product  
A suffix of "-C" specifies halogen & lead-free

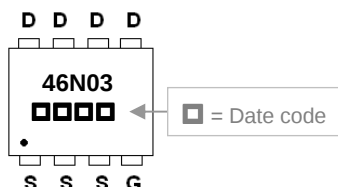
## DESCRIPTION

The SSRS46N03 provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness. The SPR-8PP package is universally preferred for all commercial-industrial surface mount applications and suited for low voltage applications such as DC/DC converters.

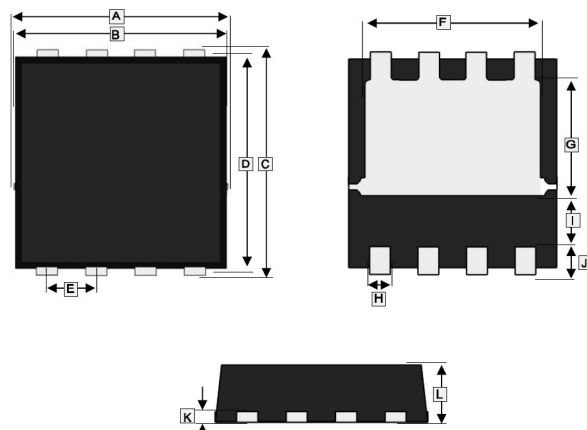
## FEATURES

- Lower Gate Charge
- Simple Drive Requirement
- Fast Switching Characteristic

## MARKING



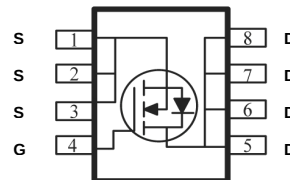
SPR-8PP



| REF. | Millimeter |      | REF. | Millimeter |      |
|------|------------|------|------|------------|------|
|      | Min.       | Max. |      | Min.       | Max. |
| A    | 3.25       | 3.40 | G    | 1.35       | 1.55 |
| B    | 3.05       | 3.25 | H    | 0.24       | 0.35 |
| C    | 3.20       | 3.40 | I    | 1.13       | REF. |
| D    | 3.00       | 3.20 | J    | 0.30       | 0.50 |
| E    | 0.65 BSC.  |      | K    | 0.10       | 0.20 |
| F    | 2.40       | 2.60 | L    | 0.70       | 0.90 |

## PACKAGE INFORMATION

| Package | MPQ | Leader Size |
|---------|-----|-------------|
| SPR-8PP | 3K  | 13 inch     |



## ABSOLUTE MAXIMUM RATINGS ( $T_A=25^\circ\text{C}$ unless otherwise specified)

| Parameter                                                   |                         | Symbol          | Rating   | Unit                        |
|-------------------------------------------------------------|-------------------------|-----------------|----------|-----------------------------|
| Drain-Source Voltage                                        |                         | $V_{DS}$        | 30       | V                           |
| Gate-Source Voltage                                         |                         | $V_{GS}$        | $\pm 20$ | V                           |
| Continuous Drain Current <sup>1</sup> @ $V_{GS}=10\text{V}$ | $T_C=25^\circ\text{C}$  | $I_D$           | 46       | A                           |
|                                                             | $T_C=100^\circ\text{C}$ |                 | 29       |                             |
|                                                             | $T_A=25^\circ\text{C}$  |                 | 11       |                             |
|                                                             | $T_A=70^\circ\text{C}$  |                 | 8.7      |                             |
| Pulsed Drain Current <sup>2</sup>                           |                         | $I_{DM}$        | 92       | A                           |
| Single Pulse Avalanche Energy <sup>3</sup>                  |                         | EAS             | 130      | mJ                          |
| Avalanche Current                                           |                         | $I_{AS}$        | 34       | A                           |
| Power Dissipation <sup>4</sup>                              | $T_A=25^\circ\text{C}$  | $P_D$           | 29       | W                           |
| Operating Junction & Storage Temperature                    |                         | $T_J, T_{STG}$  | 55~150   | $^\circ\text{C}$            |
| Thermal Resistance Rating                                   |                         |                 |          |                             |
| Thermal Resistance Junction-Ambient <sup>1</sup> (Max).     |                         | $R_{\theta JA}$ | 75       | $^\circ\text{C} / \text{W}$ |
| Thermal Resistance Junction-Case <sup>1</sup> (Max).        |                         | $R_{\theta JC}$ | 4.31     | $^\circ\text{C} / \text{W}$ |

# **ELECTRICAL CHARACTERISTICS** ( $T_J = 25^\circ\text{C}$ unless otherwise specified)

| Parameter                                      | Symbol       | Min. | Typ. | Max.      | Unit       | Teat Conditions                                              |
|------------------------------------------------|--------------|------|------|-----------|------------|--------------------------------------------------------------|
| Static                                         |              |      |      |           |            |                                                              |
| Drain-Source Breakdown Voltage                 | $BV_{DSS}$   | 30   | -    | -         | V          | $V_{GS}=0, I_D=250\mu A$                                     |
| Gate-Threshold Voltage                         | $V_{GS(th)}$ | 1    | -    | 2.5       | V          | $V_{DS}=V_{GS}, I_D=250\mu A$                                |
| Gate-Source Leakage Current                    | $I_{GSS}$    | -    | -    | $\pm 100$ | nA         | $V_{GS}= \pm 20V$                                            |
| Drain-Source Leakage Current                   | $I_{DSS}$    | -    | -    | 1         | $\mu A$    | $V_{DS}=24V, V_{GS}=0, T_J=25^{\circ}C$                      |
|                                                |              | -    | -    | 5         |            | $V_{DS}=24V, V_{GS}=0, T_J=55^{\circ}C$                      |
| Static Drain-Source On-Resistance <sup>2</sup> | $R_{DS(ON)}$ | -    | -    | 9         | m $\Omega$ | $V_{GS}=10V, I_D=30A$                                        |
|                                                |              | -    | -    | 13.5      |            | $V_{GS}=4.5V, I_D=15A$                                       |
| Gate Resistance                                | $R_g$        | -    | 2.1  | 3.5       | $\Omega$   | f =1.0MHz                                                    |
| Total Gate Charge(10V)                         | $Q_g$        | -    | 10.6 | -         | nC         | $I_D=15A$<br>$V_{DS}=15V$<br>$V_{GS}=4.5V$                   |
| Gate-Source Charge                             | $Q_{gs}$     | -    | 4.2  | -         |            |                                                              |
| Gate-Drain Change                              | $Q_{gd}$     | -    | 4    | -         |            |                                                              |
| Turn-on Delay Time <sup>2</sup>                | $T_{d(on)}$  | -    | 6.4  | -         | nS         | $V_{DD}=15V$<br>$I_D=15A$<br>$V_{GS}=10V$<br>$R_G=3.3\Omega$ |
| Rise Time                                      | $T_r$        | -    | 70.6 | -         |            |                                                              |
| Turn-off Delay Time                            | $T_{d(off)}$ | -    | 22.4 | -         |            |                                                              |
| Fall Time                                      | $T_f$        | -    | 8    | -         |            |                                                              |
| Input Capacitance                              | $C_{iss}$    | -    | 1127 | -         | pF         | $V_{GS}=0$<br>$V_{DS}=15V$<br>f =1.0MHz                      |
| Output Capacitance                             | $C_{oss}$    | -    | 194  | -         |            |                                                              |
| Reverse Transfer Capacitance                   | $C_{rss}$    | -    | 77   | -         |            |                                                              |
| Guaranteed Avalanche Characteristics           |              |      |      |           |            |                                                              |
| Single Pulse Avalanche Energy <sup>3</sup>     | EAS          | 45   | -    | -         | mJ         | $V_D=25V, L=0.1mH, I_{AS}=20A$                               |
| Source-Drain Diode                             |              |      |      |           |            |                                                              |
| Diode Forward Voltage <sup>2</sup>             | $V_{SD}$     | -    | -    | 1         | V          | $I_S=1A, V_{GS}=0, T_J=25^{\circ}C$                          |
| Continuous Source Current <sup>1,4</sup>       | $I_S$        | -    | -    | 46        | A          | $V_D=V_G=0$ , Force Current                                  |
| Pulsed Source Current <sup>2,4</sup>           | $I_{SM}$     | -    | -    | 92        | A          |                                                              |
| Reverse Recovery Time                          | $T_{rr}$     | -    | 12   | -         | nS         | $I_F=30A, dl/dt=100A/\mu S,$<br>$T_J=25^{\circ}C$            |
| Reverse Recovery Charge                        | $Q_{rr}$     | -    | 3.7  | -         | nC         |                                                              |

Note:

- The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 20Z copper ,  $\leq 10\text{sec}$  ,  $125^\circ\text{C}/\text{W}$  at steady state
- The data tested by pulsed , pulse width  $\leq 300\mu\text{s}$  , duty cycle  $\leq 2\%$
- The EAS data shows Max. rating . The test condition is  $V_{DD}=25\text{V}, V_{GS}=10\text{V}, L=0.1\text{mH}, I_{AS}=34\text{A}$
- The power dissipation is limited by  $150^\circ\text{C}$  junction temperature
- The Min. value is 100% EAS tested guarantee.
- The data is theoretically the same as  $I_D$  and  $I_{DM}$  , in real applications , should be limited by total power dissipation.

## CHARACTERISTIC CURVES

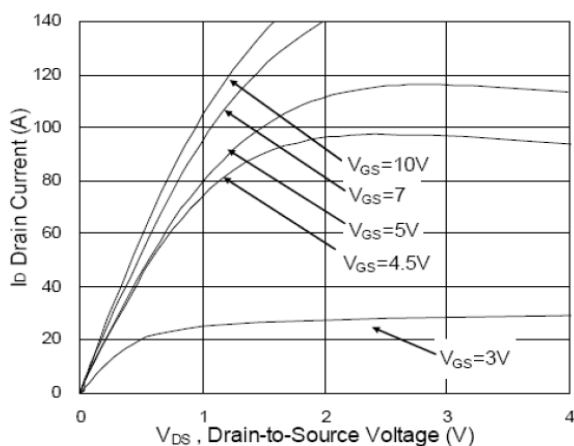


Fig.1 Typical Output Characteristics

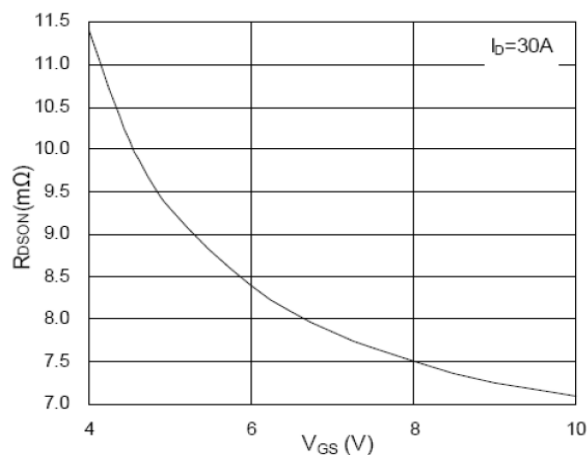


Fig.2 On-Resistance vs. Gate-Source

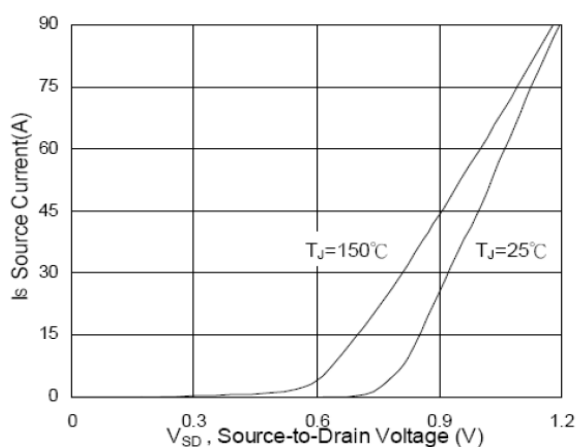


Fig.3 Forward Characteristics of Reverse

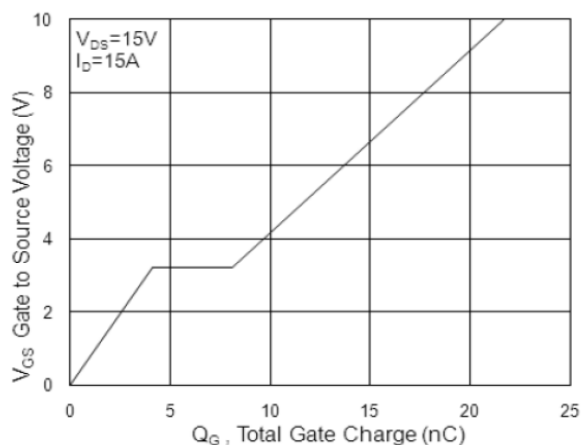


Fig.4 Gate-Charge Characteristics

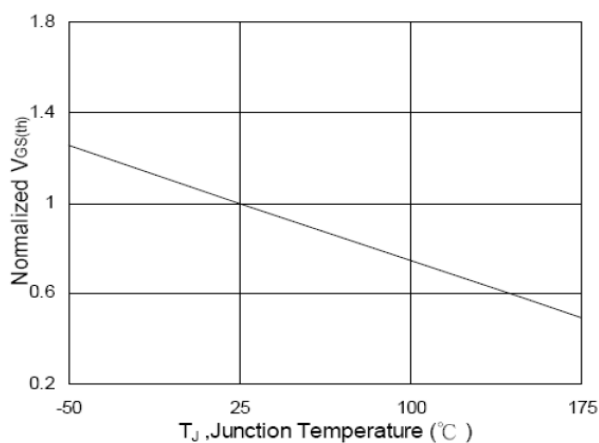


Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$

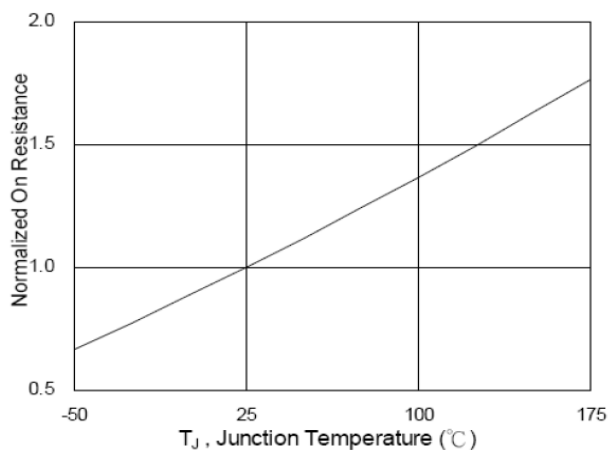


Fig.6 Normalized  $R_{DS(ON)}$  vs.  $T_J$

## CHARACTERISTIC CURVES

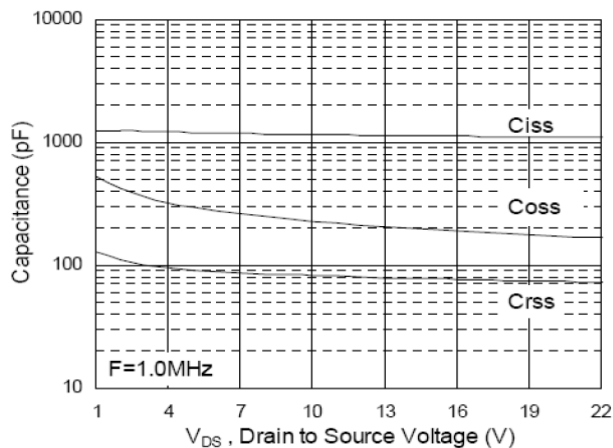


Fig.7 Capacitance

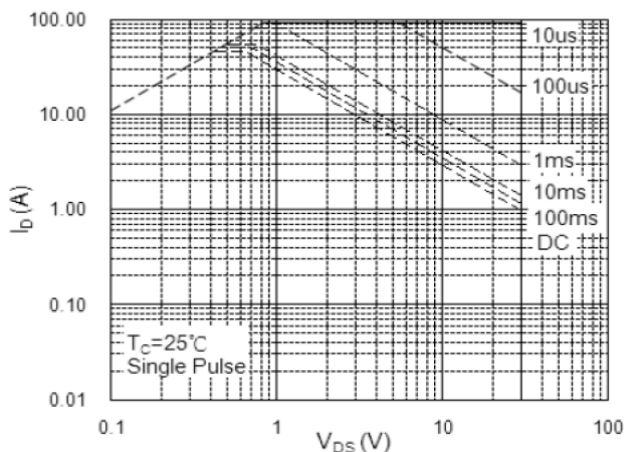


Fig.8 Safe Operating Area

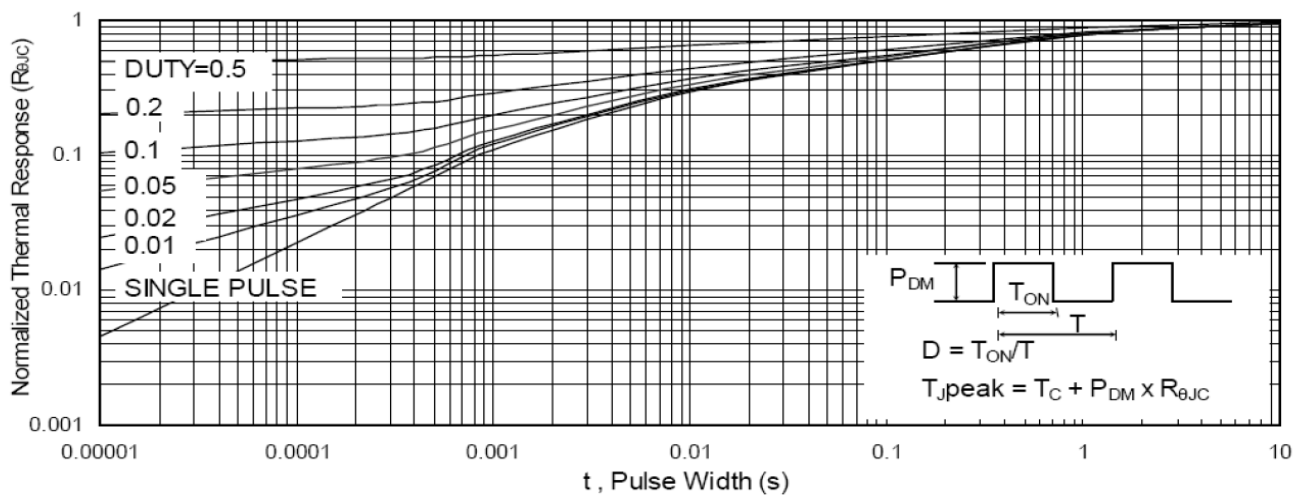


Fig.9 Normalized Maximum Transient Thermal Impedance

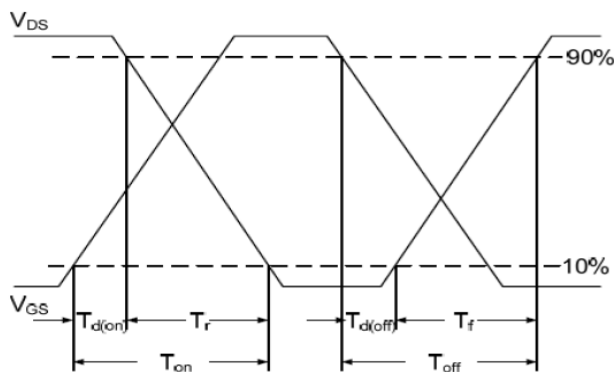


Fig.10 Switching Time Waveform

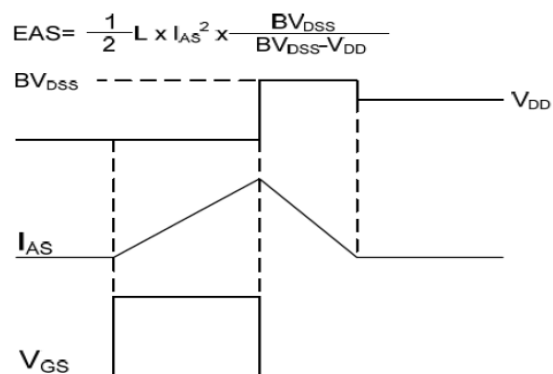


Fig.11 Unclamped Inductive Switching Wave